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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

FEB 23 2005

Applicant: Bu et al.

Art Unit: 2825

Serial No.: 10/662,850

Examiner: Lee, C.

Filing Date: 09/15/2003

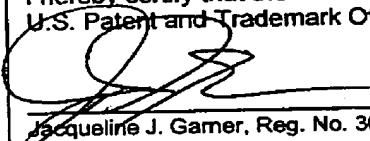
Docket No.: TI-36162

Customer No.: 23494

Conf. No.: 2124

Title: INTEGRATION OF PRE-S/D ANNEAL SELECTIVE NITRIDE/OXIDE  
COMPOSITE CAP FOR IMPROVING TRANSISTOR PERFORMANCE

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## FACSIMILE COVER SHEET

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NAME OF INVENTOR(S):	
<b>Bu</b>	
TITLE OF INVENTION:	
<b>Integration of Pre-S/D ...</b>	
TI FILE NO.:	DEPOSIT ACCT. NO.:
<b>TI-36162</b>	<b>20-0668</b>
FAXED: 2/23/2005	
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